# XP161A1355PR



ETR1124\_001

#### **Power MOSFET**

## **■**GENERAL DESCRIPTION

The XP161A1355PR is an N-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

A gate protect diode is built-in to prevent static damage.

The small SOT-89 package makes high density mounting possible.

## ■APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

# **■**FEATURES

**Low On-State Resistance** : Rds (on)=  $0.05\Omega$  @ Vgs = 4.5V

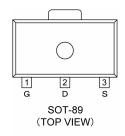
: Rds (on)=  $0.07 \Omega$  @ Vgs = 2.5V : Rds (on)=  $0.15 \Omega$  @ Vgs = 1.5V

Ultra High-Speed Switching
Gate Protect Diode Built-in
Driving Voltage : 1.5V
N-Channel Power MOSFET

**DMOS Structure** 

Small Package : SOT-89

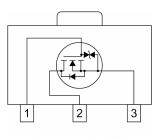
# **■PIN CONFIGURATION**



## ■PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTION
1	G	Gate
2	D	Drain
3	S	Source

# **■**EQUIVALENT CIRCUIT



N-channel MOSFET (1 device built-in)

#### ■ ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

	14 - Z				
PARAMETER	SYMBOL	RATINGS	UNITS		
Drain-Source Voltage	Vdss	20	V		
Gate-Source Voltage	Vgss	±8	V		
Drain Current (DC)	ld	4	Α		
Drain Current (Pulse)	ldp	16	Α		
Reverse Drain Current	ldr	4	Α		
Channel Power Dissipation *	Pd	2	W		
Channel Temperature	Tch	150	°C		
Storage Temperature Range	Tstg	-55~150	°C		

<sup>\*</sup> When implemented on a ceramic PCB

# **■**ELECTRICAL CHARACTERISTICS

DC Characteristics Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds=20V, Vgs= 0V	-	-	10	μΑ
Gate-Source Leak Current	lgss	Vgs= ±8V, Vds= 0V	-	-	±10	μΑ
Gate-Source Cut-Off Voltage	Vgs(off)	Id= 1mA, Vds= 10V	0.5	-	1.2	V
Drain-Source On-State Resistance *1	Rds(on)	Id= 2A, Vgs= 4.5V	-	0.037	0.050	Ω
		Id= 2A, Vgs= 2.5V	1	0.05	0.07	Ω
		Id= 0.5A, Vgs= 1.5V	1	0.1	0.15	Ω
Forward Transfer Admittance *1	Yfs	ld= 2A, Vds= 10V	-	10	-	S
Body Drain Diode Forward Voltage	Vf	If= 4A, Vgs= 0V	-	0.85	1.1	V

<sup>\*1</sup> Effective during pulse test.

#### **Dynamic Characteristics**

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds= 10V, Vgs=0V f= 1MHz	-	390	-	pF
Output Capacitance	Coss		-	210	-	pF
Feedback Capacitance	Crss		- 1	90	1	pF

# **Switching Characteristics**

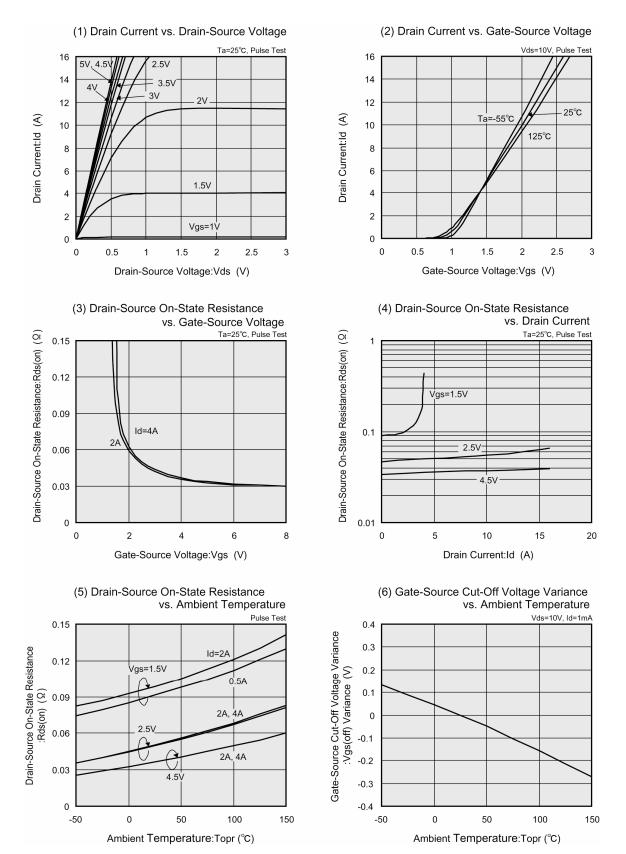
Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)		ı	10	ı	ns
Rise Time	tr	Vgs= 5V, Id=2A Vdd= 10V	-	15	-	ns
Turn-Off Delay Time	td (off)		-	85	-	ns
Fall Time	tf		-	45	-	ns

#### **Thermal Characteristics**

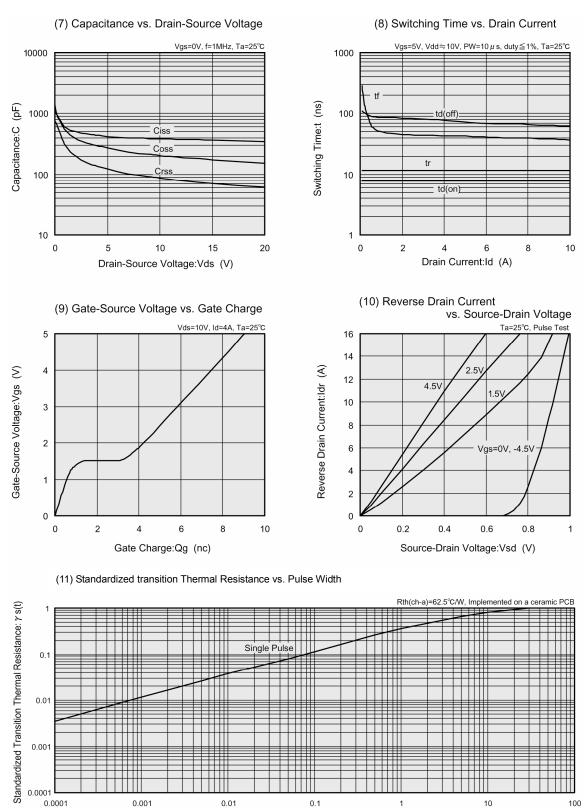
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a ceramic PCB	ı	62.5	ı	°C/W

# **■**TYPICAL PERFORMANCE CHARACTERISTICS



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# ■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



Pulse Width:PW (s)

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